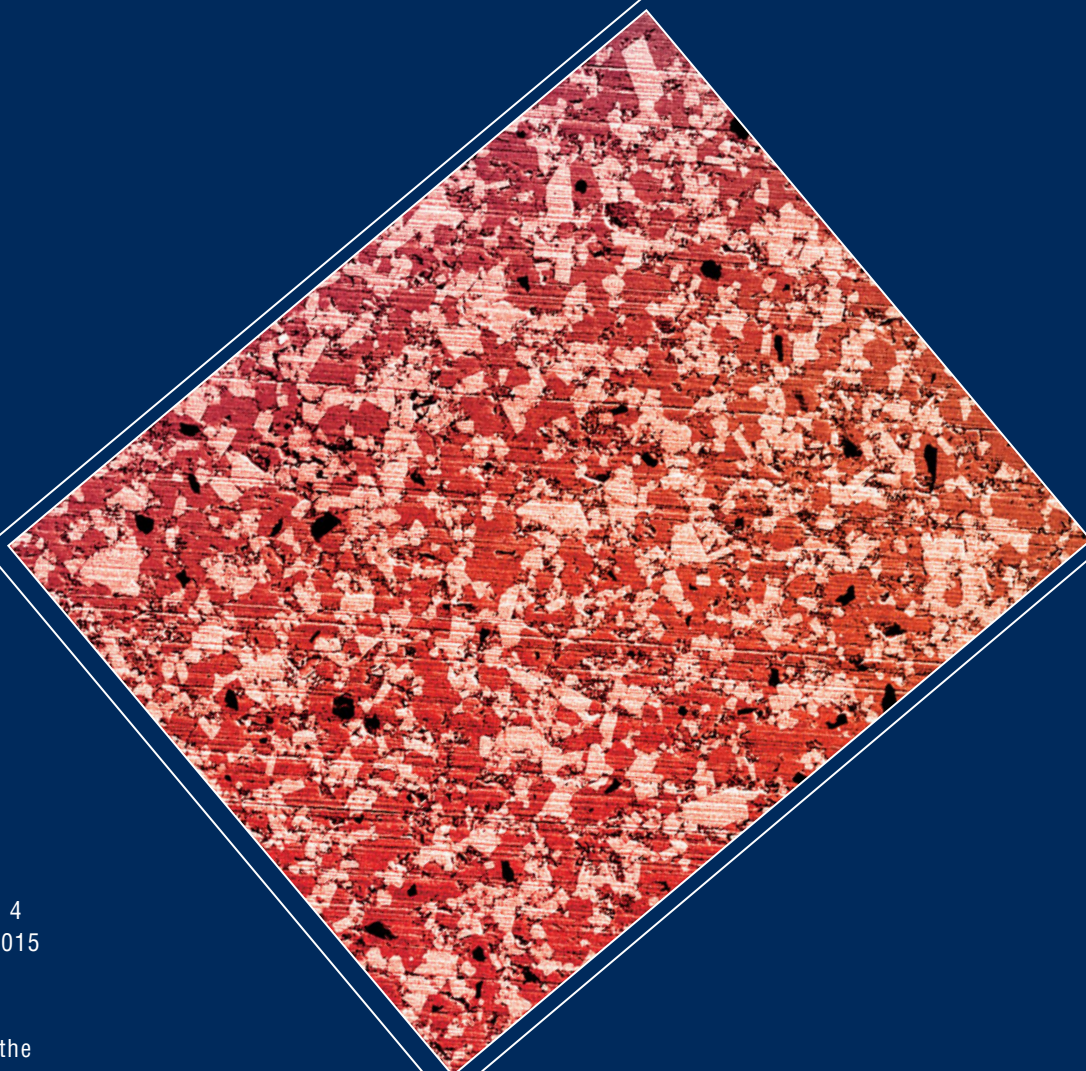


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Cover: FIG. 1(a). Surface morphology of YT14 substrate. [K. Jun and F. Zhong: Friction and wear behaviors of AlTiCrN coatings by cathodic arc ion plating at high temperatures. p. 503].

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